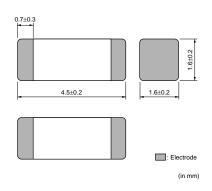
### Data Sheet

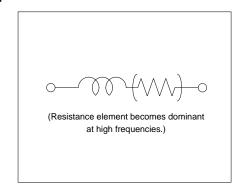
# EMIFIL® (Inductor type) Chip Ferrite Bead

## **BLM41P Series (1806 Size)**

### ■ Dimensions



### **■** Equivalent Circuit



### ■ Packaging

Code	Packaging	Minimum Quantity	
L	180mm Embossed Tape	2500	
K	330mm Embossed Tape	8000	
В	Bulk(Bag)	1000	

### ■ Rated Value (□: packaging code)

Part Number	Impedance (at 100MHz/20°C)	Impedance (at 1GHz/20°C)	Rated Current	DC Resistance	Operating Temperature Range
BLM41PG600SN1□	60ohm (Typ.)	-	6000mA	0.01ohm max.	-55 to +125°C
BLM41PG750SN1□	75ohm (Typ.)	-	3000mA	0.025ohm max.	-55 to +125°C
BLM41PG181SN1□	180ohm ±25%	-	3000mA	0.025ohm max.	-55 to +125°C
BLM41PG471SN1□	470ohm ±25%	-	2000mA	0.05ohm max.	-55 to +125°C
BLM41PG102SN1□	1000ohm ±25%	-	1500mA	0.09ohm max.	-55 to +125°C

Number of Circuits: 1

Continued on the following page.

This data sheet is applied for CHIP FERRITE BEAD used for General Electronics equipment for your design.

### **⚠ Note:**

- 1. This datasheet is downloaded from the website of Murata Manufacturing co., ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
- This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

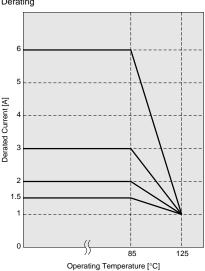
Continued from the preceding page.

### ■ Derating of Rated Current

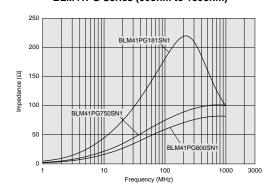
In operating temperature exceeding +85°C, derating of current is necessary for BLM41PG series.

Please apply the derating curve shown in chart according to the operating temperature.

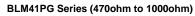
Derating

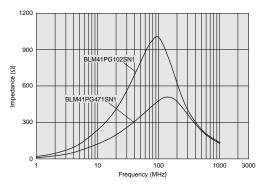


■ Impedance-Frequency Characteristics (Main Items) BLM41PG Series (60ohm to 180ohm)



■ Impedance-Frequency Characteristics (Main Items)





Continued on the following page.

• This data sheet is applied for CHIP FERRITE BEAD used for General Electronics equipment for your design.

### **⚠ Note:**

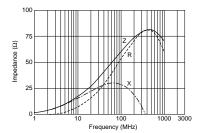
- 1. This datasheet is downloaded from the website of Murata Manufacturing co., ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
- 2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

### Data Sheet

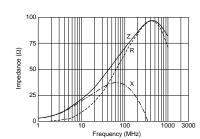
Continued from the preceding page.

**■** Impedance-Frequency Characteristics

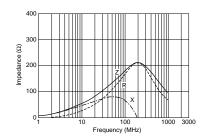




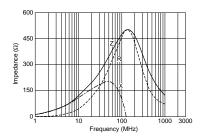
■ Impedance-Frequency Characteristics BLM41PG750SN1



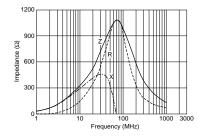
■ Impedance-Frequency Characteristics BLM41PG181SN1



■ Impedance-Frequency Characteristics BLM41PG471SN1



■ Impedance-Frequency Characteristics BLM41PG102SN1



Continued on the following page.

• This data sheet is applied for CHIP FERRITE BEAD used for General Electronics equipment for your design.

### **⚠ Note:**

- 1. This datasheet is downloaded from the website of Murata Manufacturing co., ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
- 2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

# Noise Suppression Products/EMI Suppression Filters > EMIFIL® (Inductor type) > Chip Ferrite Bead Data Sheet 4 Continued from the preceding page. Caution/Notice Caution/Rating) Do not use products beyond the rated current as this may create excessive heat and deteriorate the insulation resistance. Notice Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

This data sheet is applied for CHIP FERRITE BEAD used for General Electronics equipment for your design.

### **⚠ Note:**

- 1. This datasheet is downloaded from the website of Murata Manufacturing co., ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
- 2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

2011.5.12